

Analog Electronic Circuits (UEC301)

By



Dr. Mayank Kumar Rai
Associate Professor,
ECED, TIET, Patiala

Thapar Institute of Engineering & Technology
(Deemed to be University)
Bhadson Road, Patiala, Punjab, Pin-147004
Contact No. : +91-175-2393201
Email : info@thapar.edu

ti
THAPAR INSTITUTE
OF ENGINEERING & TECHNOLOGY
(Deemed to be University)

Subject: Analog Electronic Circuits (UEC301)

Faculty name: Dr. Mayank Kumar Rai (Associate Professor & Course Coordinator)

Topic of today's Lecture : *Metal Oxide Semiconductor Field Effect Transistor (MOSFET)*

Key points

- ✓ **Difference between BJT and MOSFET**
- ✓ **MOSFET Types and symbols**
- ✓ **Basic Construction and operation of enhancement type NMOS**
- ✓ **Transfer Characteristics**

Contents of this lecture are based on the following books:

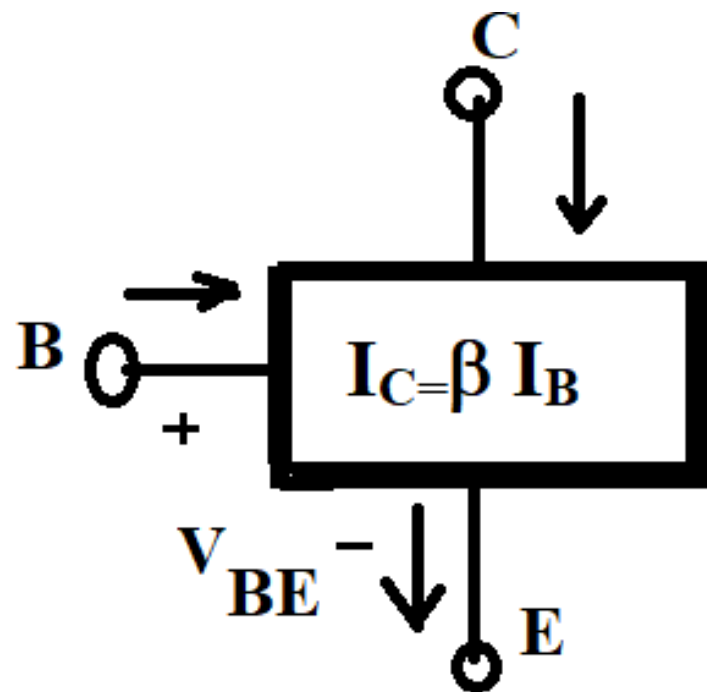
- *Jacob Milman & C.C.Halkias, “Integrated Electronics Analog and Digital Circuit and Systems” Second Edition.*
- *Adel S. Sedra & K. C. Smith, “MicroElectronic Circuits Theory and Application” Fifth Edition.*
- *Robert L. Boylestad & L. Nashelsky, “Electronic Devices and Circuit Theory” Eleventh Edition.*



Difference between BJT and MOSFET

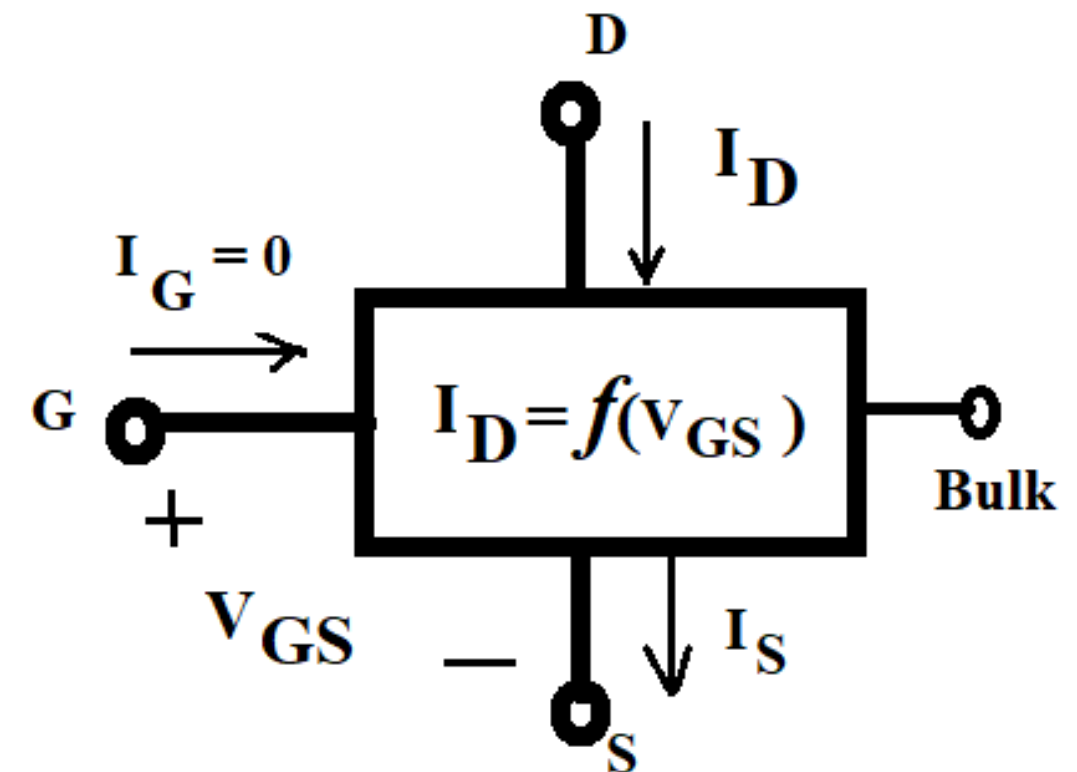
BJT

- Current Controlled current Device
- Input impedance is very small
- Bipolar
- Types: n-p-n and p-n-p



MOSFET

- Voltage controlled Current device
- Input impedance is very high
- Unipolar
- Types: Depletion and enhancement type



MOSFET Types and Symbols

✓ Depletion type

(n-channel and p-channel)

✓ Enhancement type

(n-channel and p-channel)

❖ *n-channel depletion and p-channel depletion*

❖ *n-channel enhancement mode and p-channel enhancement mode*

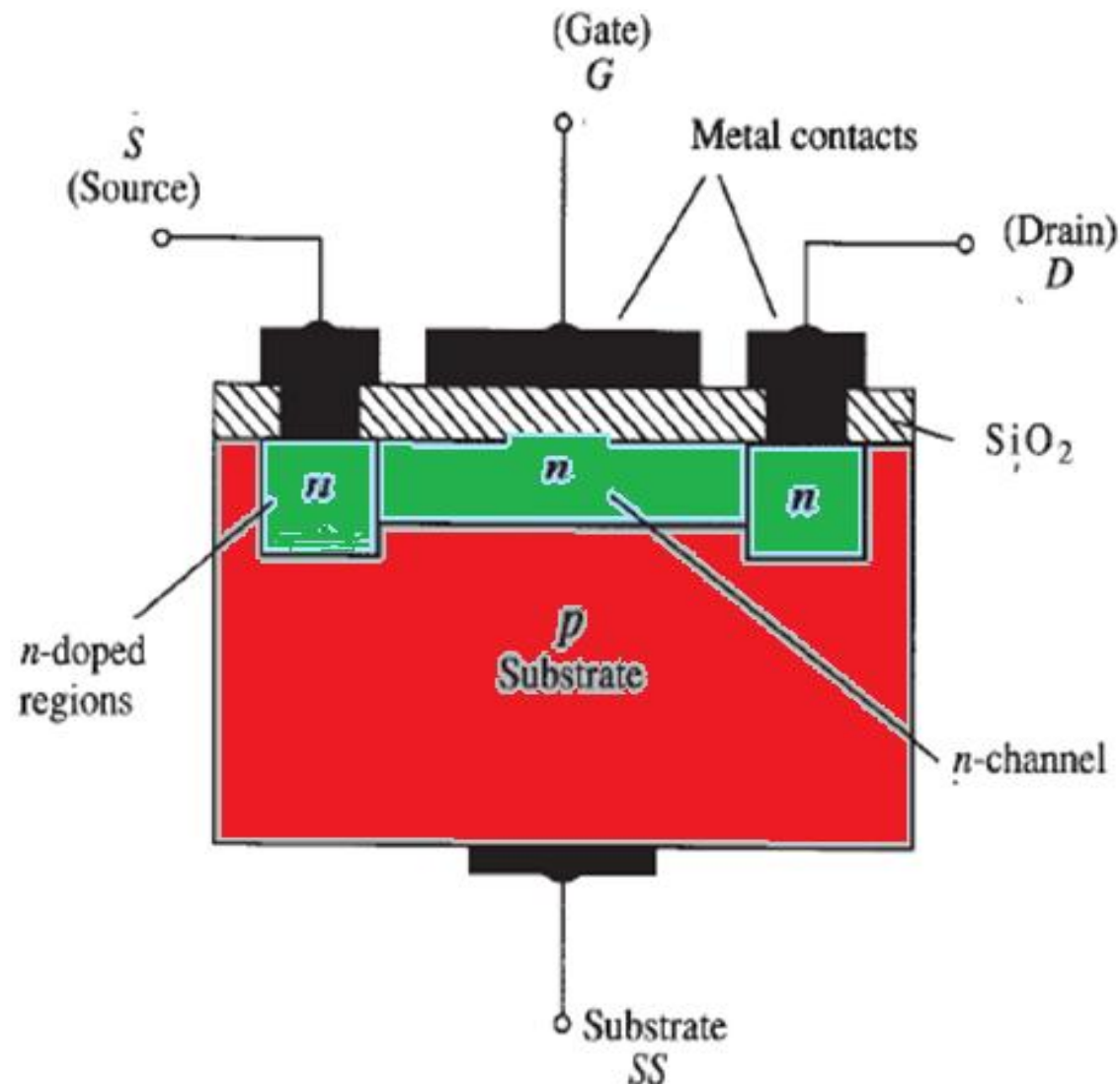


Figure 1 :The n- channel depletion type MOSFET.

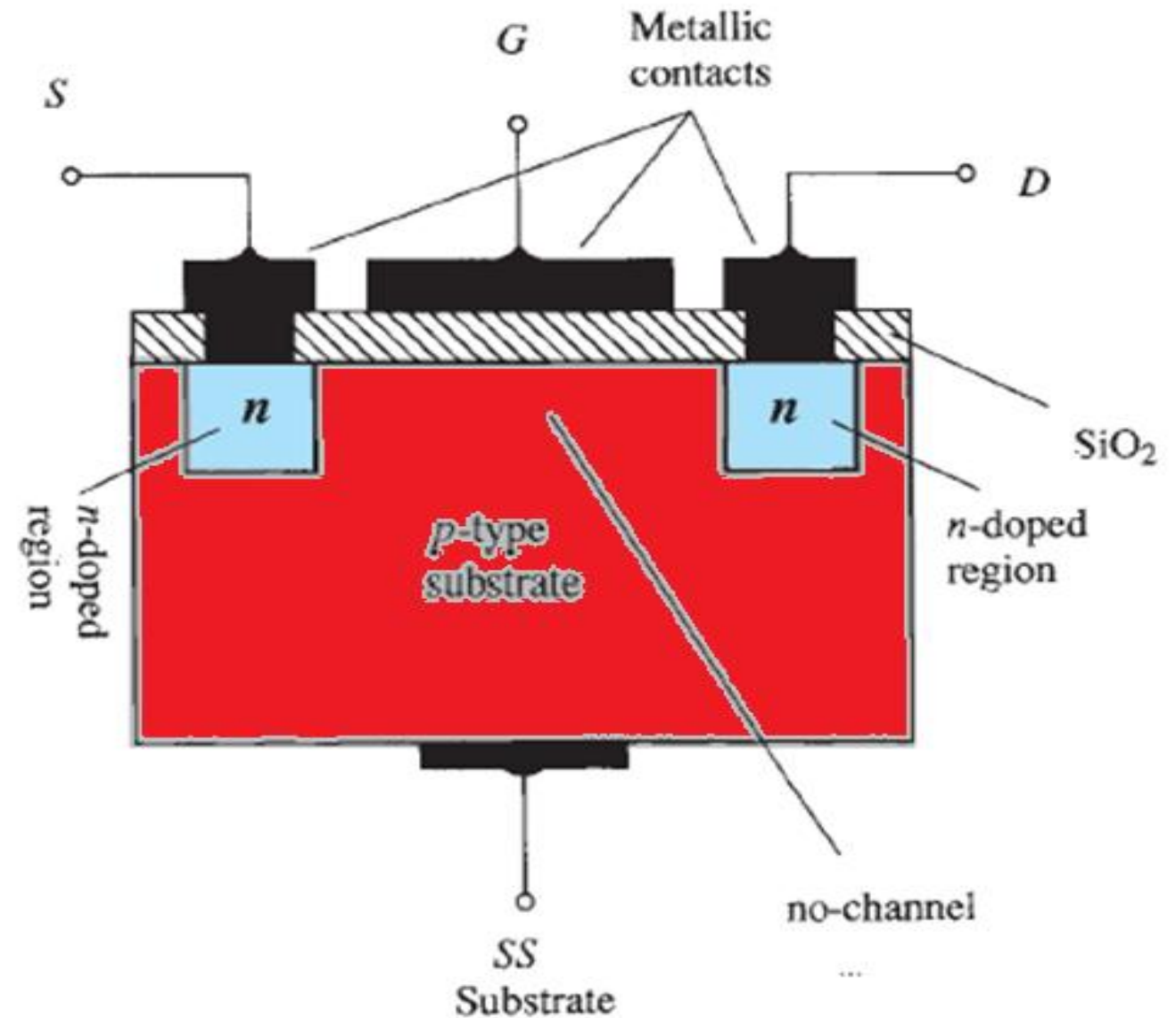
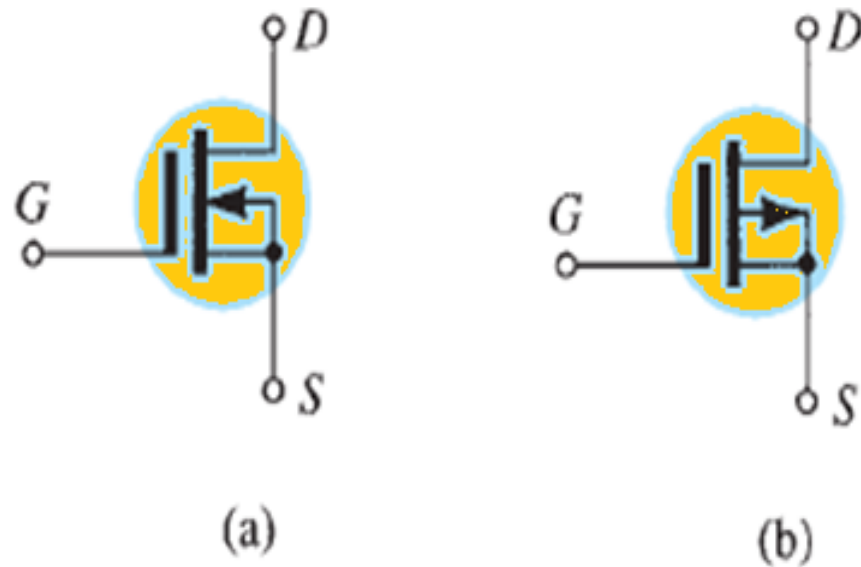
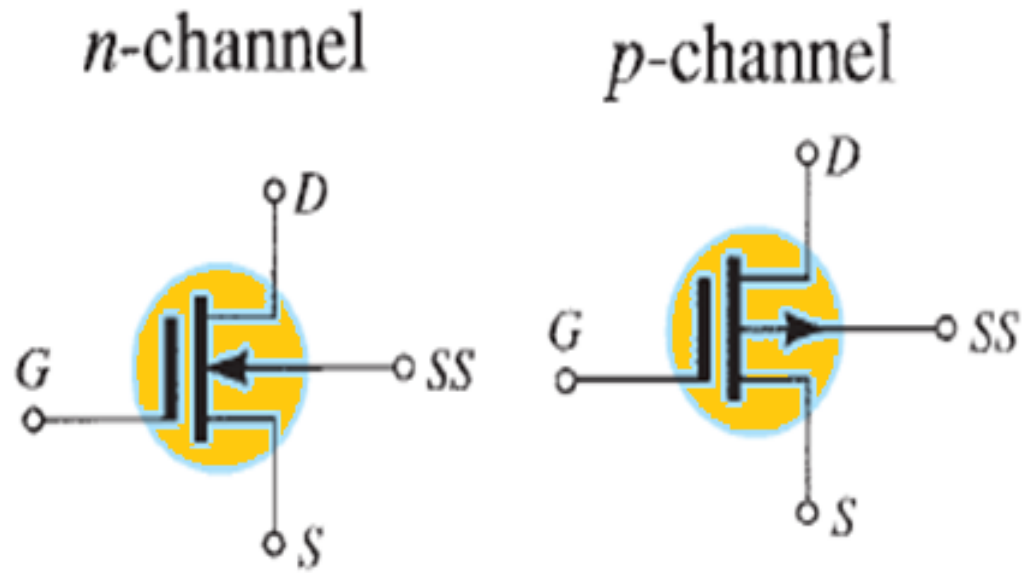
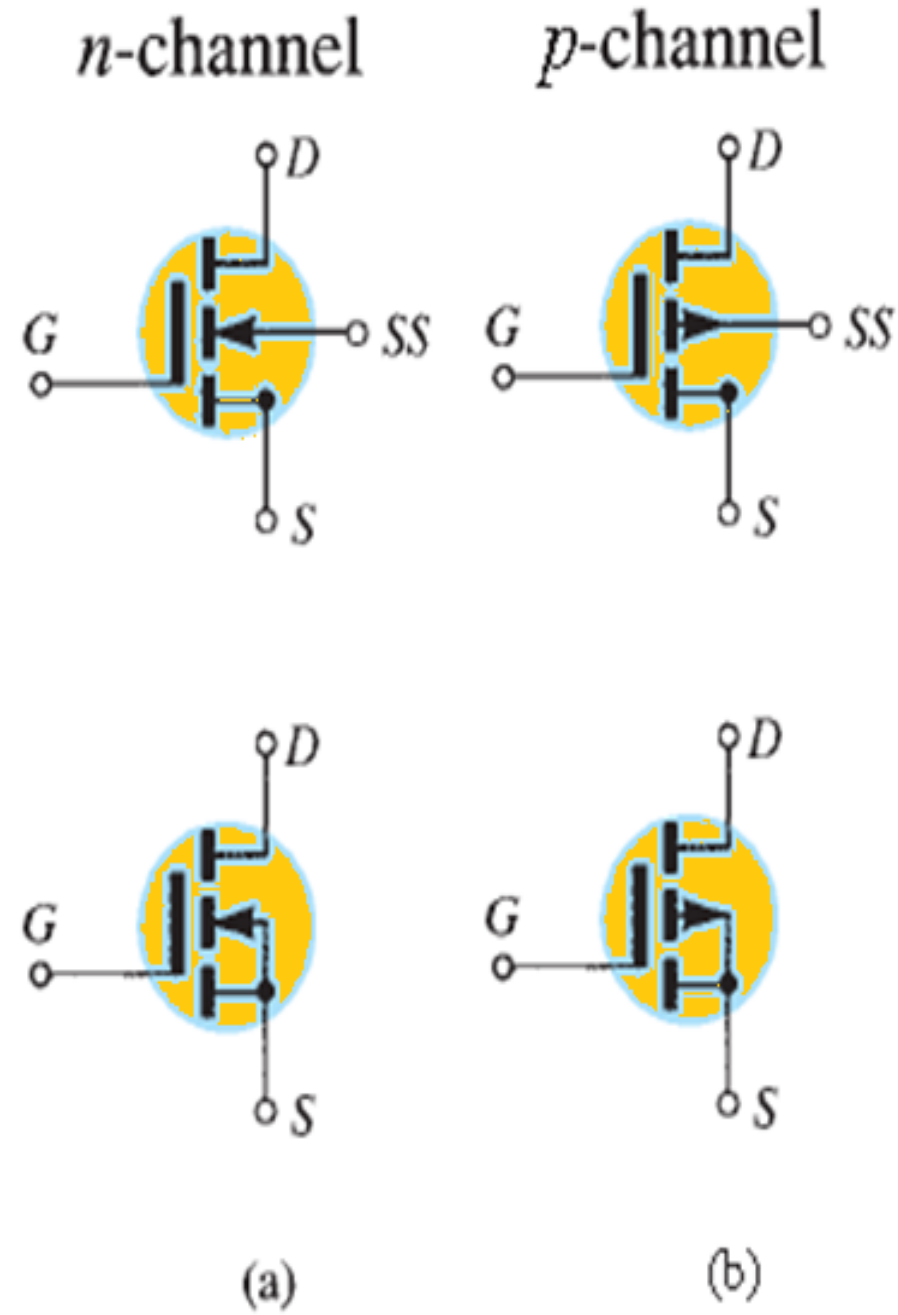


Figure 2 :The n- channel enhancement type MOSFET.

Symbols



Symbols for : (a) *n*- channel depletion type and
(b) *p*-channel depletion type MOSFETs



Symbols for : (a) *n*-channel enhancement and (b) *p*-channel
enhancement MOSFETs

Basic Construction of n-channel enhancement type MOSFET(NMOS)

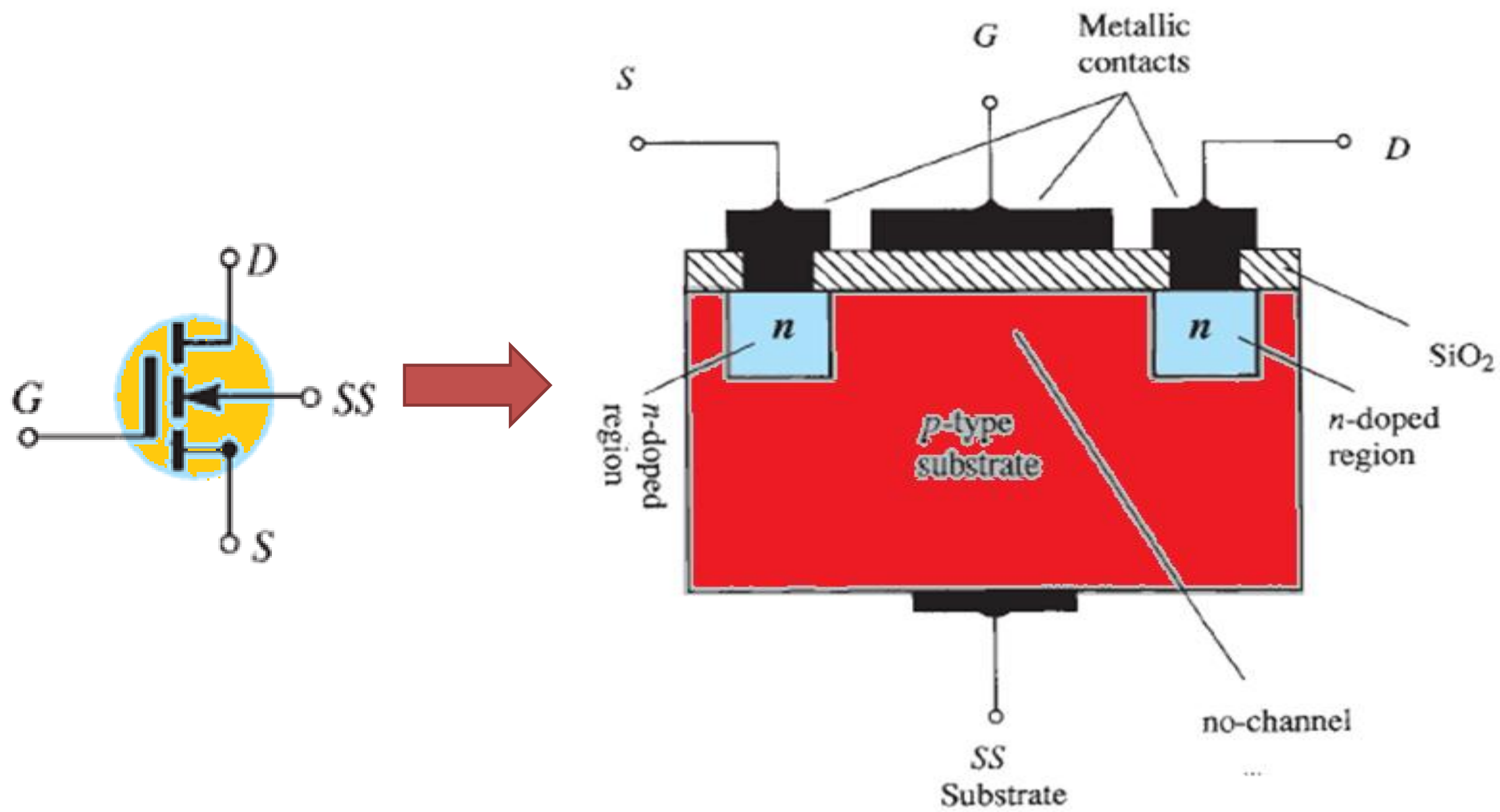


Figure 3 :The n- channel enhancement type MOSFET.

Operation of n-channel enhancement type MOSFET(NMOS)

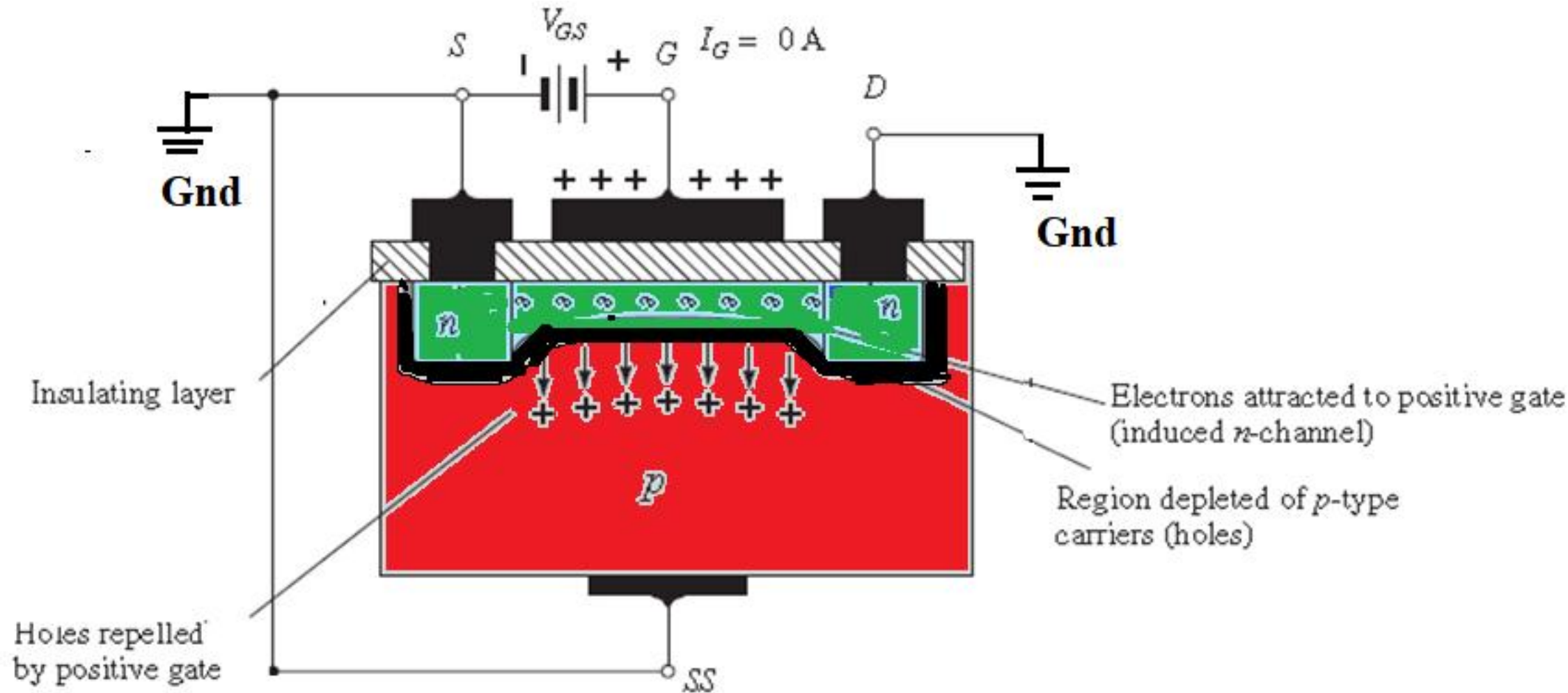


Figure 4: Channel formation in the n- channel enhancement type MOSFET.

Case-1

- ✓ $V_{GS} = V_{to}$ (threshold voltage) and $V_{DS} = 0$
- ✓ $I_D = 0$
- ✓ Causing an Inversion
(conducting Channel is formed between Source and Drain)

$$V_{to} = \Phi_{MS} + 2\Phi_F + \gamma(\sqrt{2\Phi_F}),$$

$$\text{Where } \gamma = \left(\sqrt{2q N_{sub} \epsilon_{si}} \right),$$

$$\Phi_F = \frac{KT}{q} \ln \left(\frac{N_{sub}}{n_i} \right),$$

and Φ_{MS} is the difference between the work functions of polysilicon gate and the silicon substrate

Case-2: $V_{GS} > V_{to}$ (threshold voltage) and small $V_{DS} > 0$

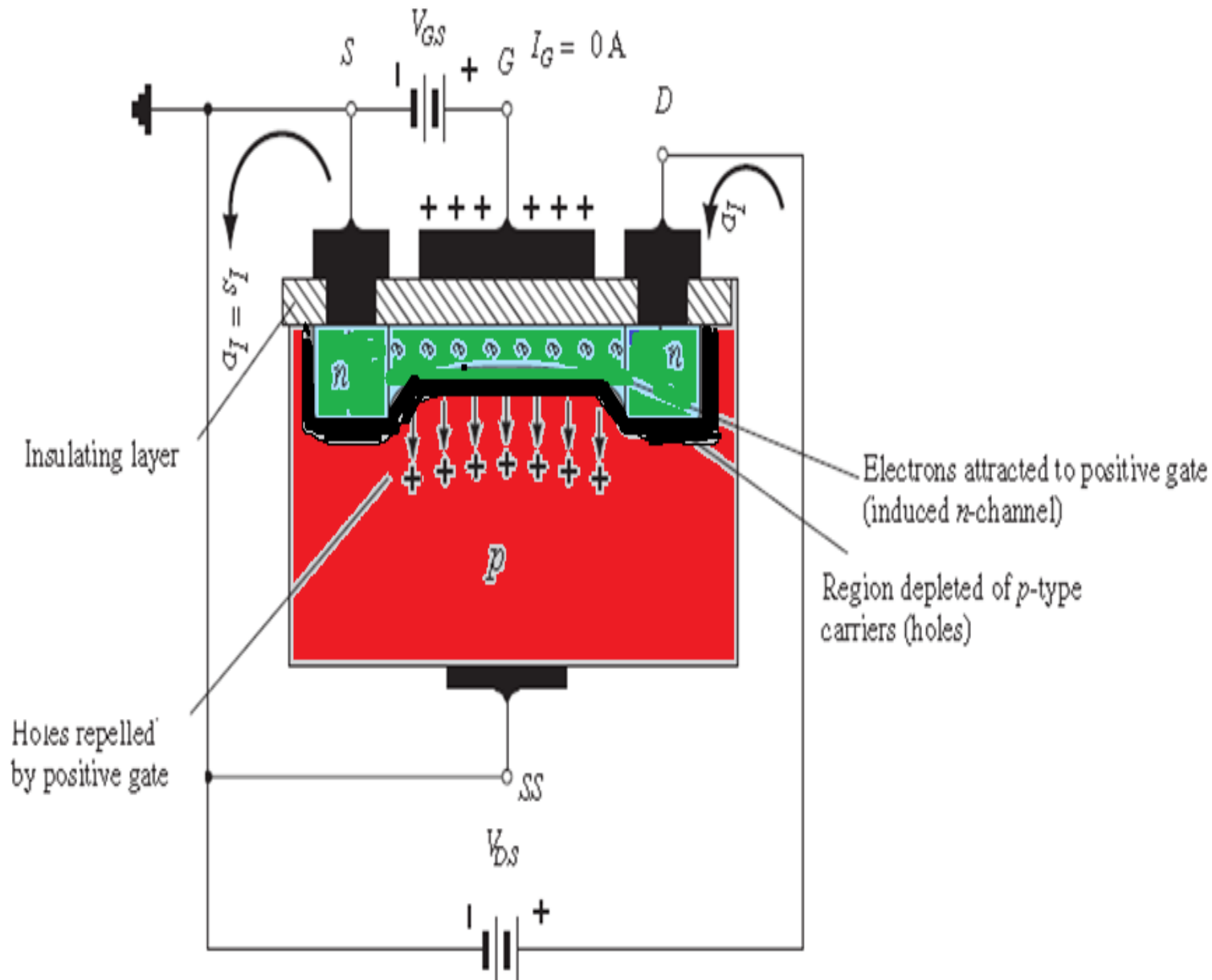


Figure 5: The n- channel enhancement type MOSFET with external bias.

$$I_D = \mu_n C_{OX} \frac{W}{L} (V_{GS} - V_{to}) V_{DS} - \frac{(V_{DS})^2}{2}$$

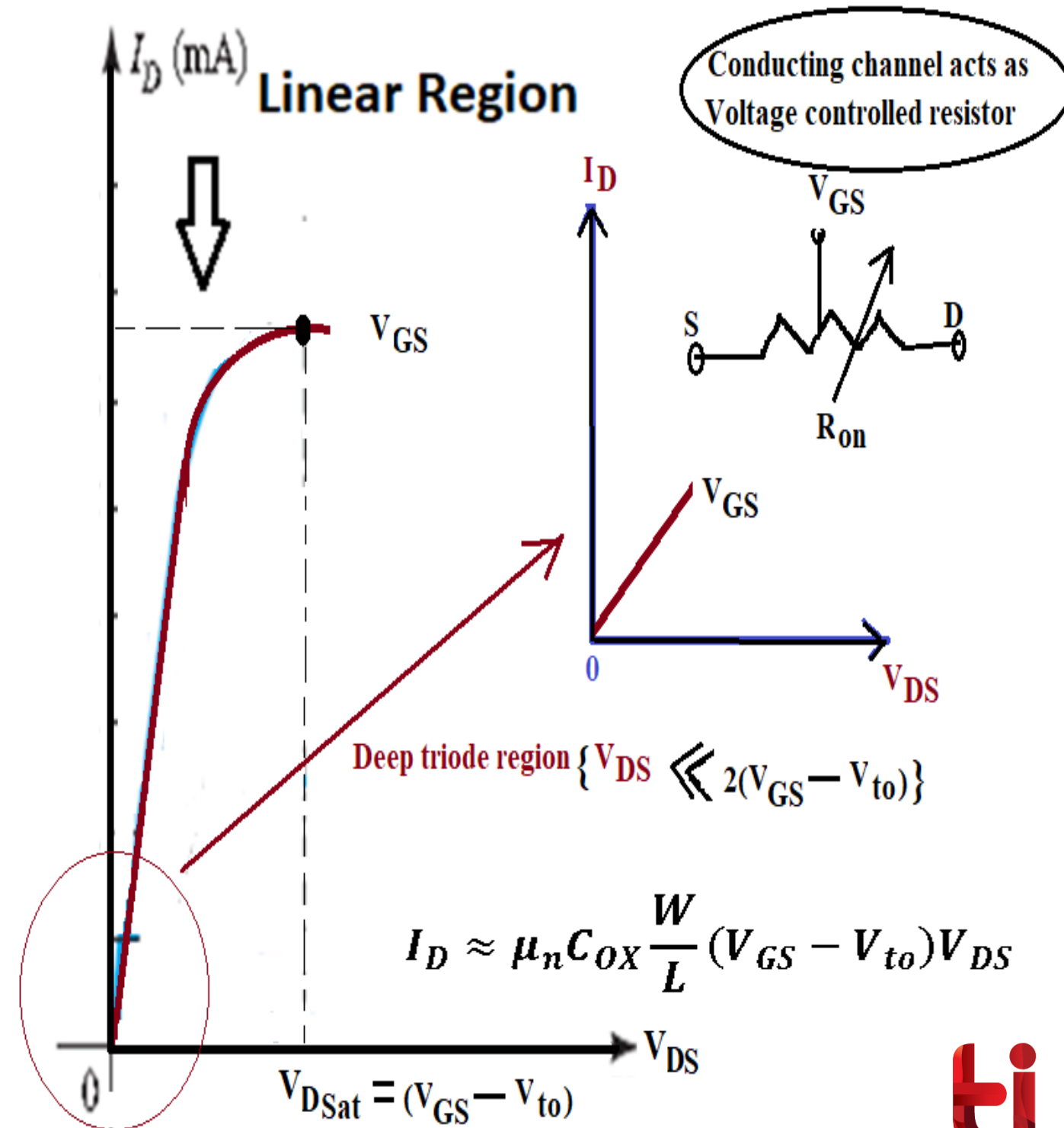


Figure 6: Linear operation of NMOS in deep triode region.

Case-3: $V_{GS} > V_{to}$ and $V_{DS} = V_{DS}$

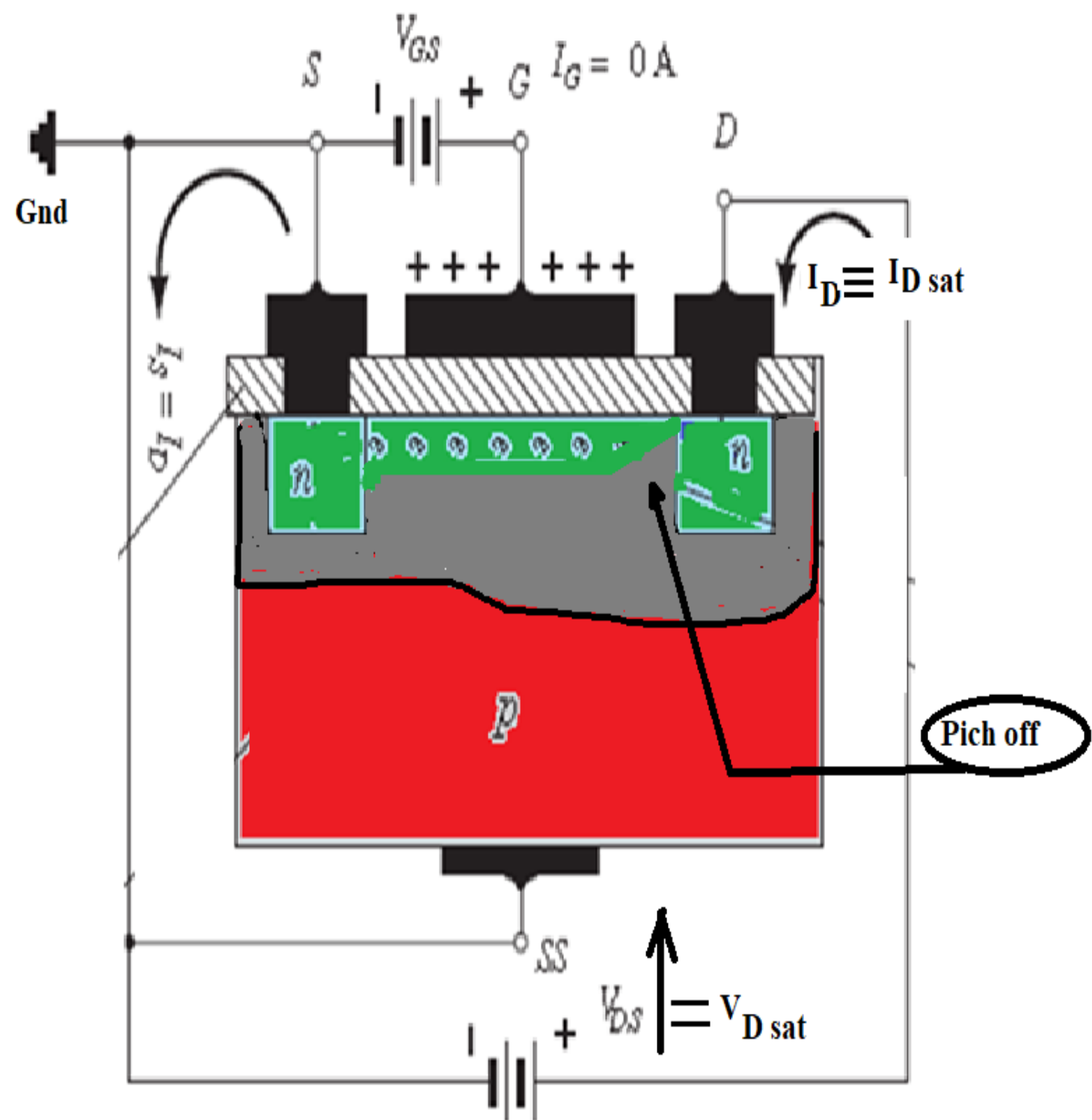


Figure7:The n- channel enhancement type MOSFET under pinch off condition.

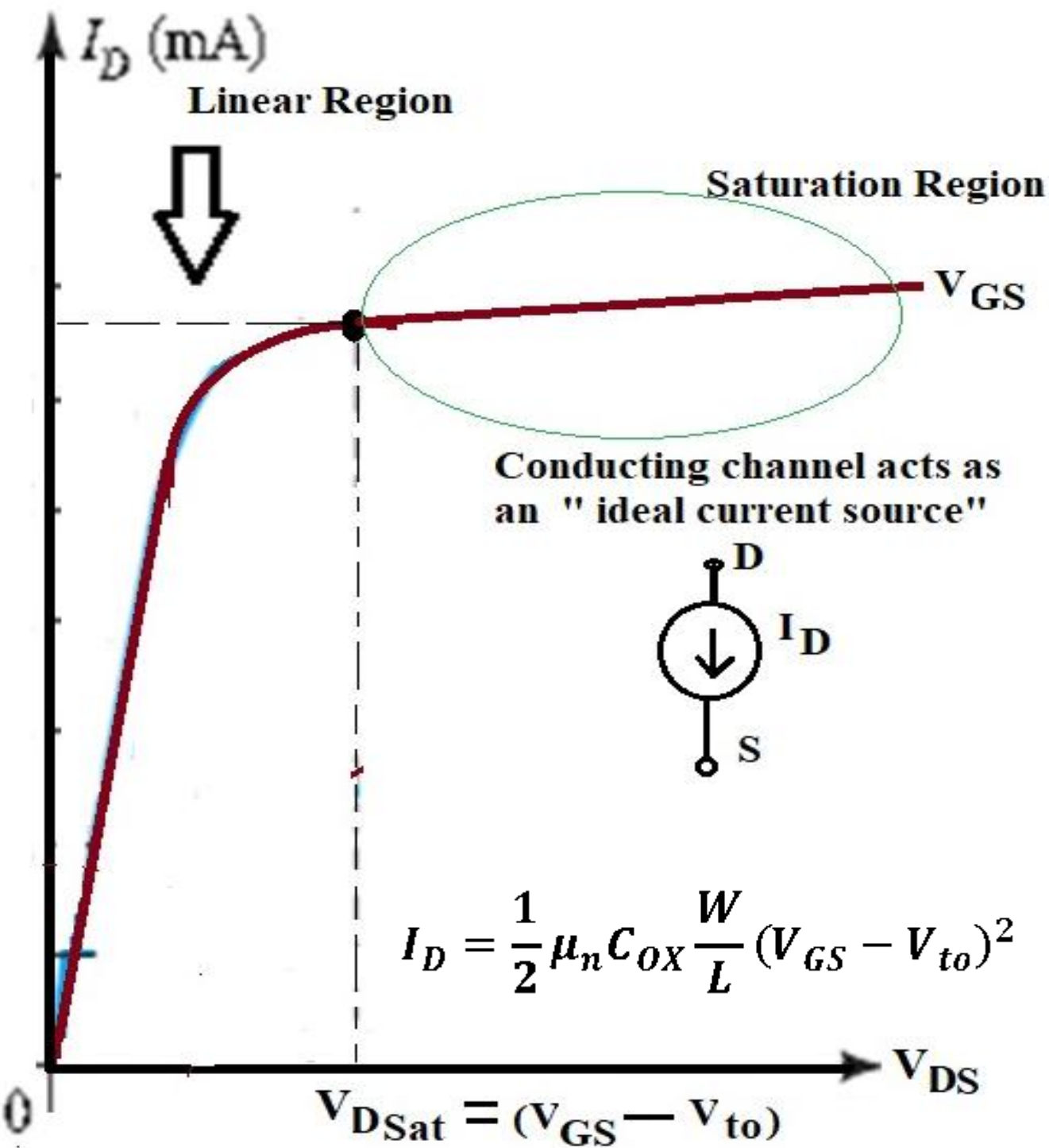


Figure 8: Operation of NMOS under Saturation region.

Case-4: $V_{GS} > V_{to}$ and $V_{DS} > V_{DS\text{ at}}$

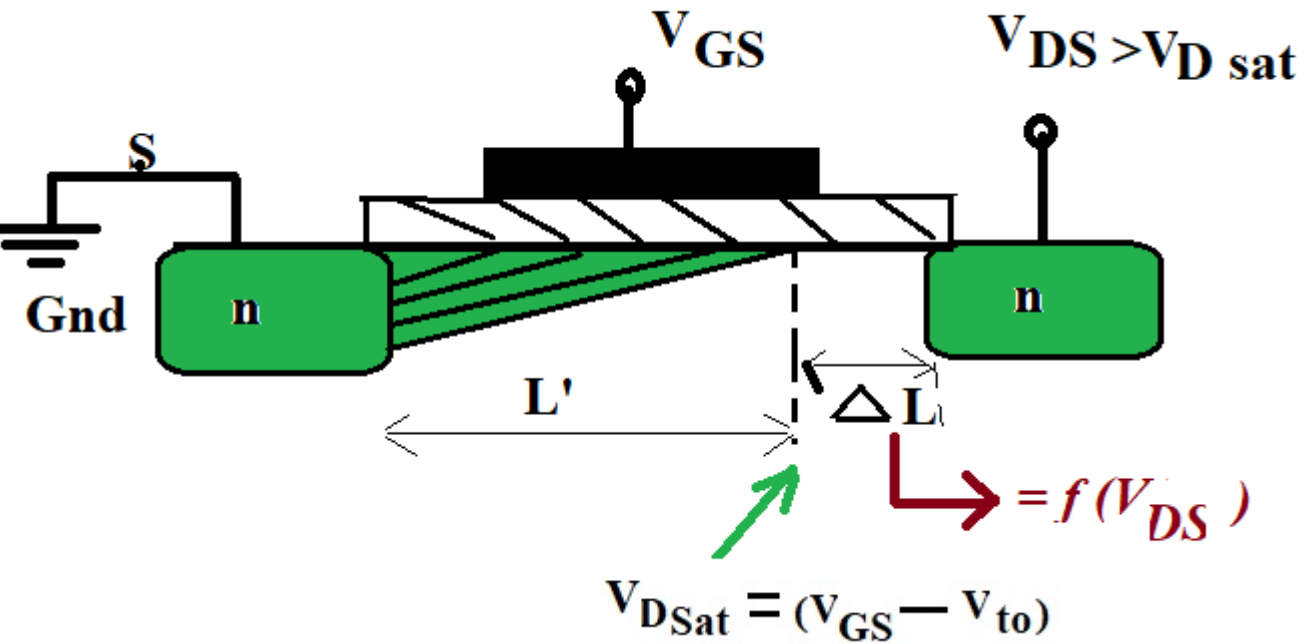


Figure 9: Variation of channel length of the n- channel enhancement type MOSFET under channel length modulation.

As V_{DS} increases further ($V_{DS} > V_{DS\text{ at}}$), the channel gradually moves toward the source end i.e. The channel length decreases (L) with increase in V_{DS}

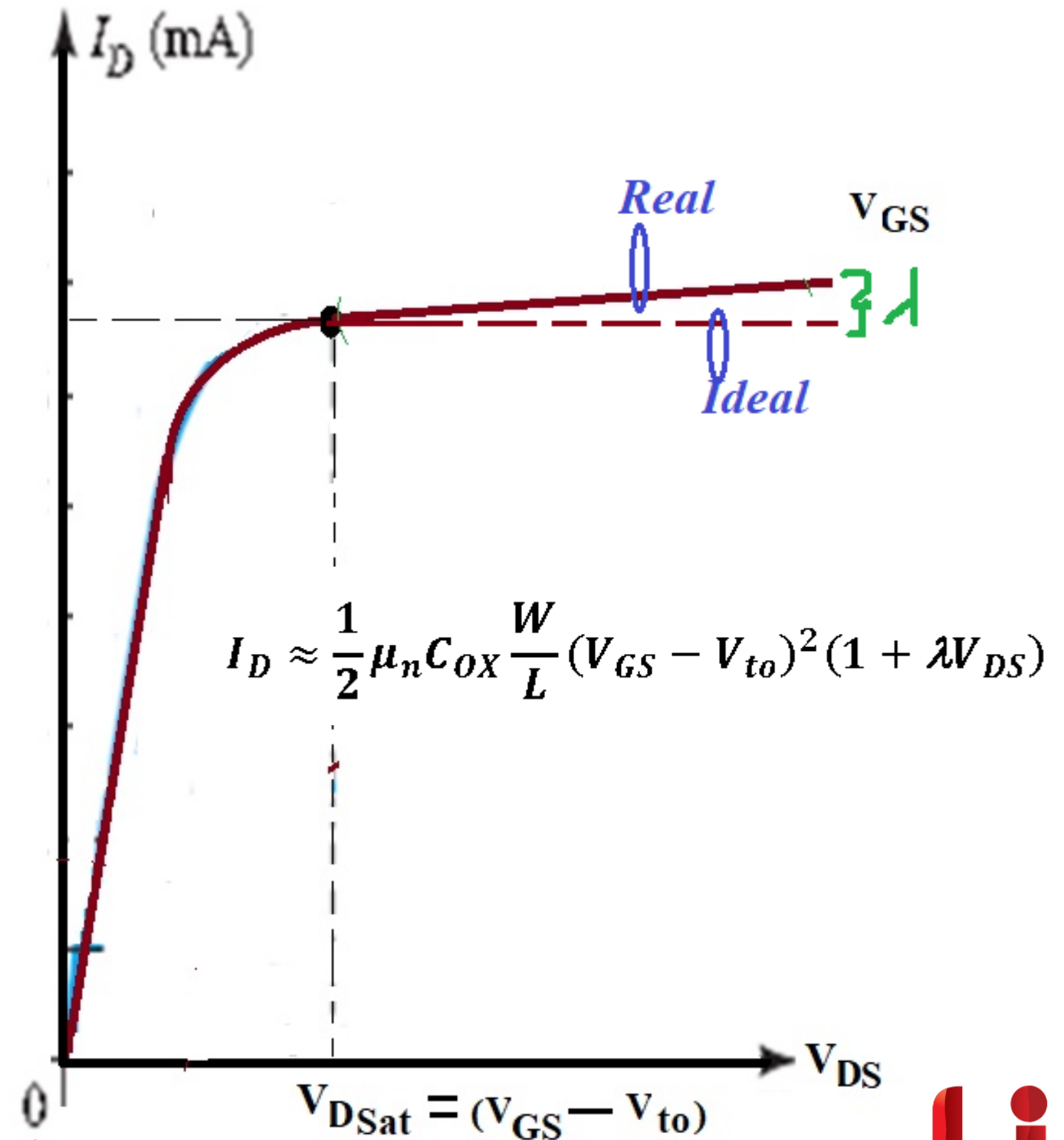
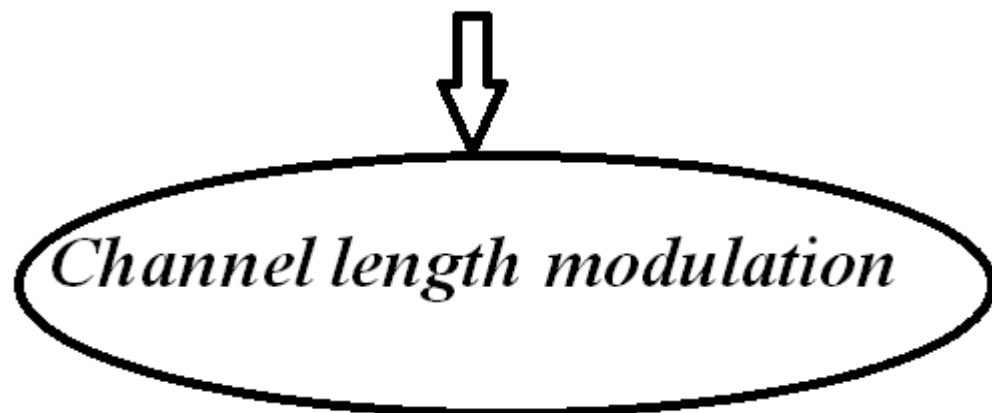


Figure 10: Output characteristic of the n- channel enhancement type MOSFET under channel length modulation.

Output characteristics of enhancement type NMOS

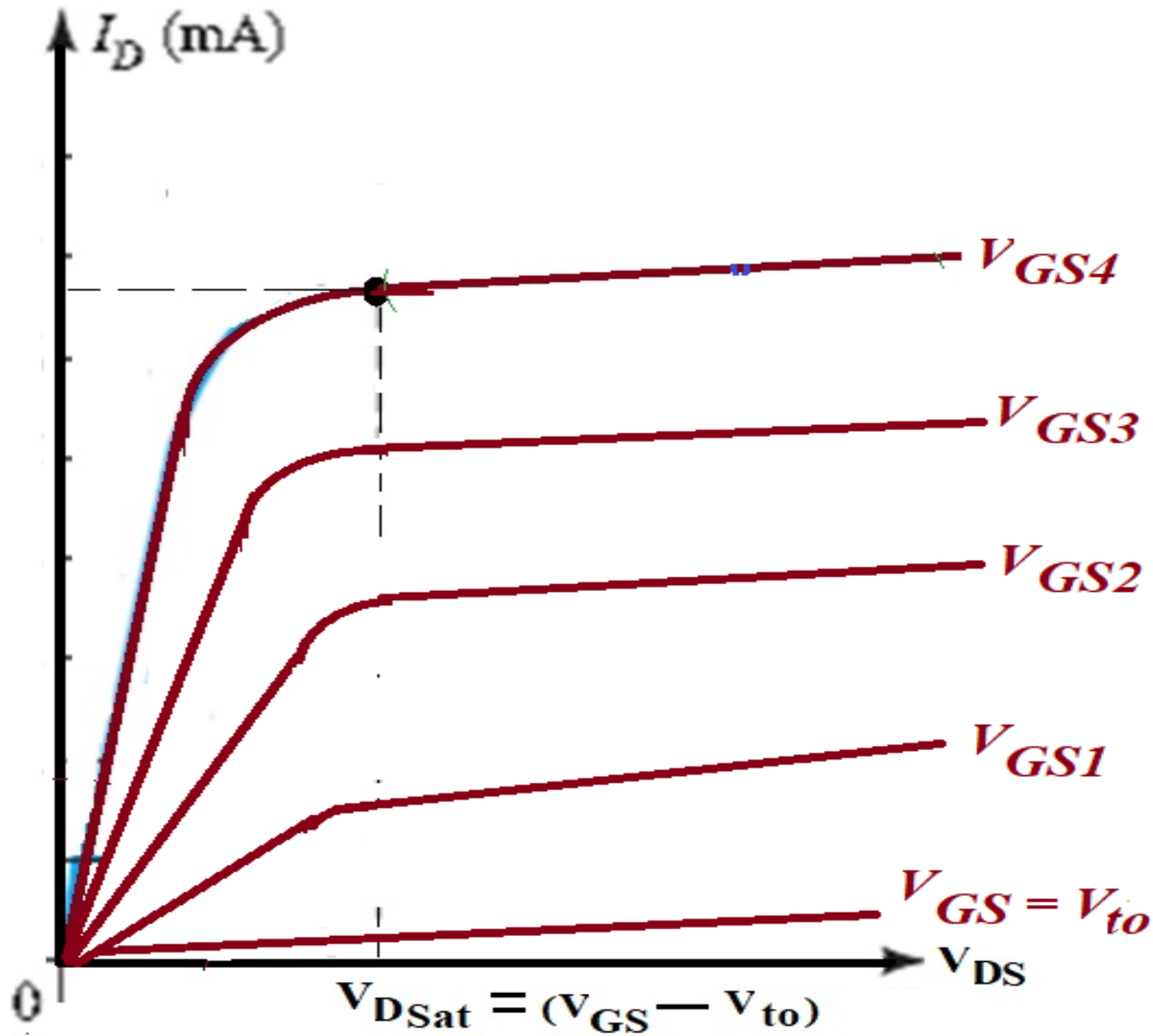
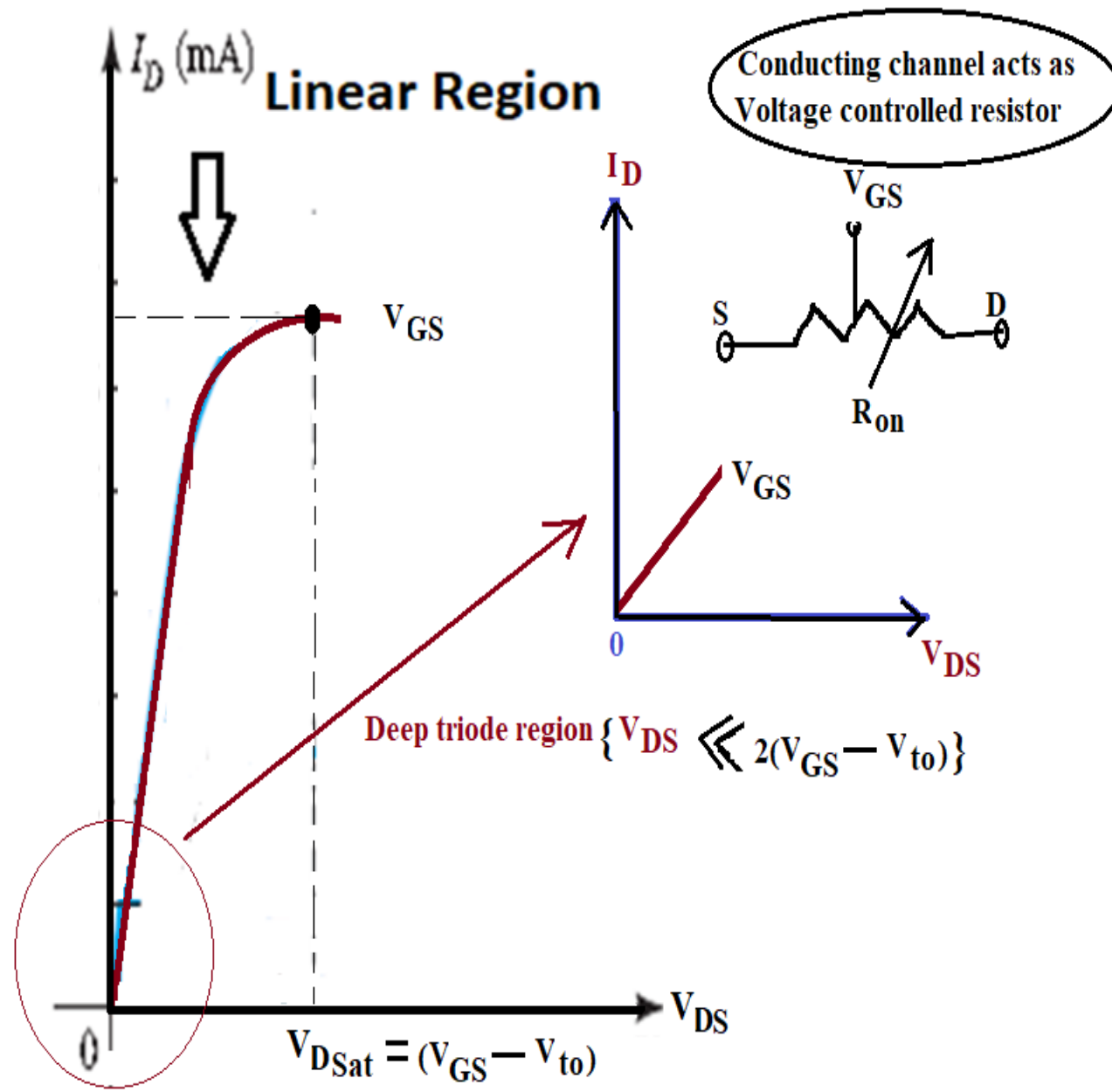


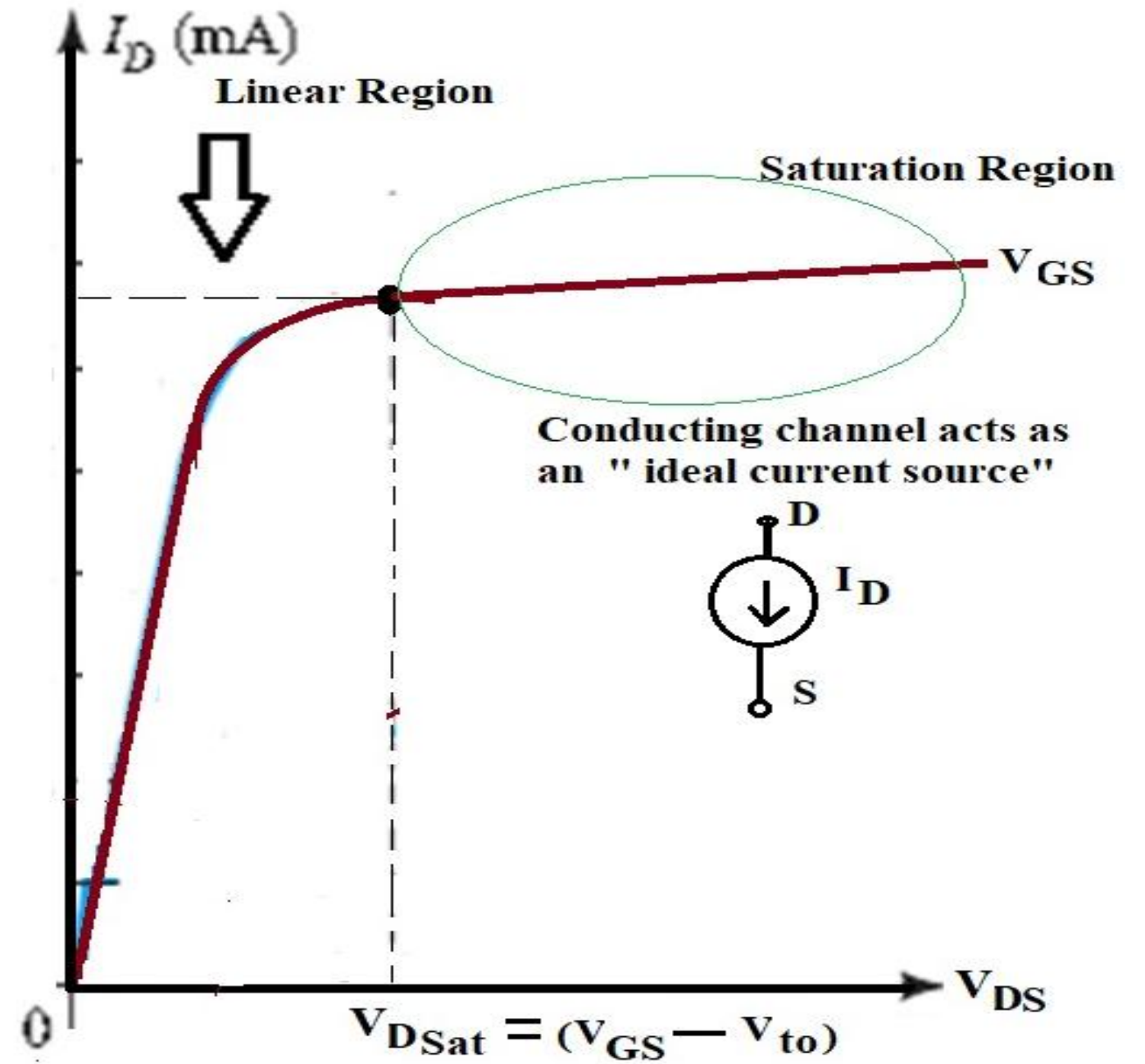
Figure 11: Output characteristics of the n- channel enhancement type MOSFET.



Summary



Triode(Linear) Region



Saturation Region

Thank You

